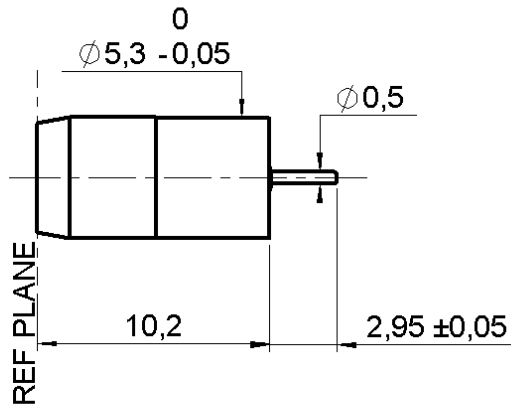


**SOLDER MALE RECEPTACLE**

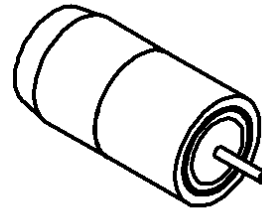
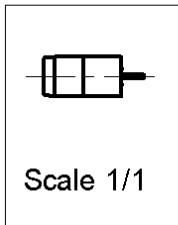
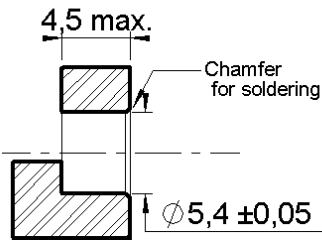
**HERMETIC - GLASS BEAD**

**R128.630.000**

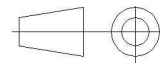
Series : BMA



**PANEL PERCING**



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
BODY	FERRO-NICKEL	GOLD 0.5 OVER NICKEL 4
CENTER CONTACT	BRASS	GOLD 1.3 OVER NICKEL 2
OUTER CONTACT	-	-
INSULATOR	PTFE	-
GASKET	-	-
OTHERS PARTS	-	-
-	-	-
-	-	-

Issue : 0449 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



**SOLDER MALE RECEPTACLE**

**R128.630.000**

**HERMETIC - GLASS BEAD**

Series : **BMA**

**PACKAGING**

**SPECIFICATION**

Standard	Unit	Other
<b>1</b>	-	<b>Contact us</b>

**ELECTRICAL CHARACTERISTICS**

Impedance		<b>50</b> Ω
Frequency		<b>0-22</b> GHz
VSWR	<b>1.25</b> * +	<b>0.000</b> x F(GHz) Maxi
Insertion loss		<b>0.07</b> √F(GHz) dB Maxi
RF leakage	- (	<b>NA</b> - F(GHz)) dB Maxi
Voltage rating		<b>500</b> Veff Maxi
Dielectric withstanding voltage		<b>1500</b> Veff mini
Insulation resistance		<b>5000</b> MΩ mini

**ENVIRONMENTAL**

Operating temperature	<b>-65/+125</b> ° C
Hermetic seal	<b>10-5</b> Atm.cm <sup>3</sup> /s
Panel leakage	<b>NA</b>

**OTHERS CHARACTERISTICS**

Assembly instruction

Others :

\* de 0 -10 Ghz

**MECHANICAL CHARACTERISTICS**

Center contact retention		
Axial force – Mating end	<b>27</b>	N mini
Axial force – Opposite end	<b>27</b>	N mini
Torque	<b>NA</b>	N.cm mini
Recommended torque		
Mating	<b>NA</b>	N.cm
Panel nut	<b>NA</b>	N.cm
Mating life	<b>1000</b>	Cycles mini
Weight	<b>0.000</b>	g

Issue : 0449 B

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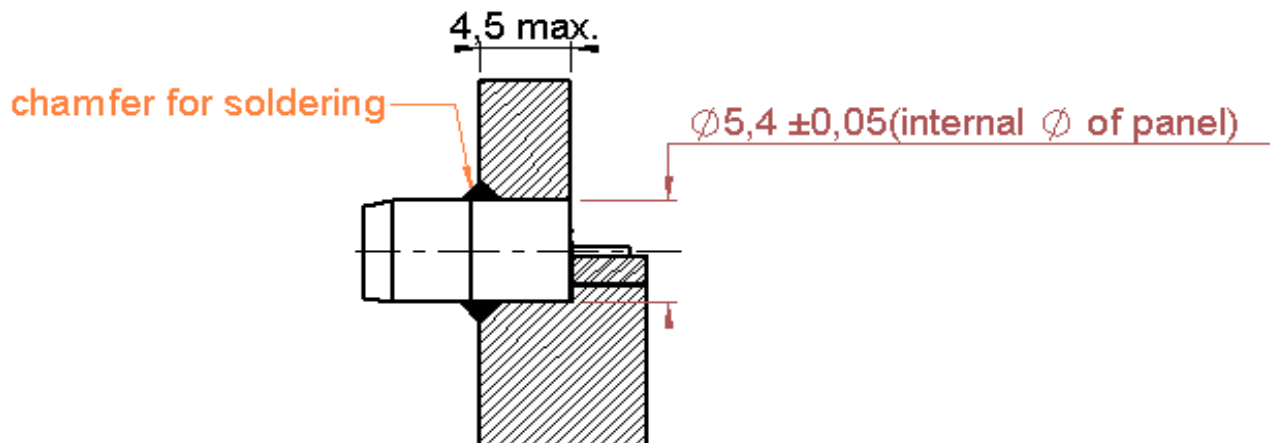


**SOLDER MALE RECEPTACLE****R128.630.000****HERMETIC - GLASS BEAD**

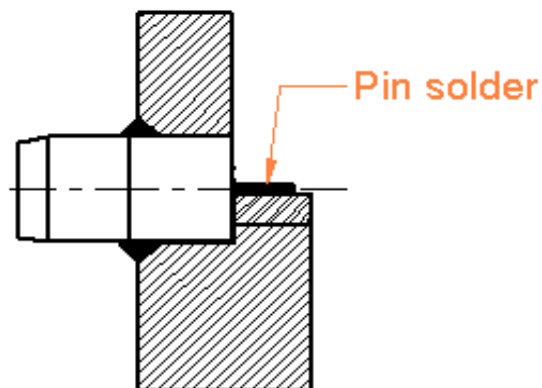
Series : BMA

**MOUNTING HOLE DETAIL**

Degrease and clean connector and box.  
Solder the connector on the panel.  
Preheating at about 100°C  
Take care not to exceed 250°C during solder operation.



Solder the pin on the track.  
Ceramic substrates : preheating at about 100°C  
Other substrates : no preheating required.



NOTE :  
Please use a small soldering iron, or hot air soldering system.

Issue : 0449 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.

